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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon NPN Triple Diffused

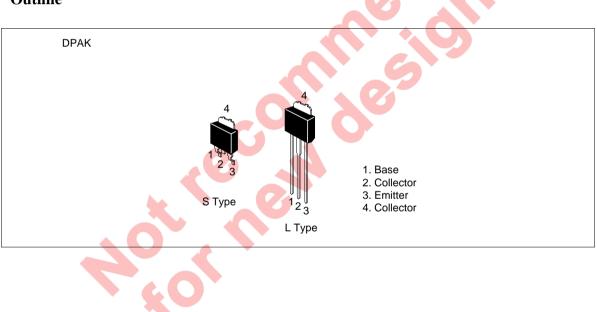
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ADE-208-893 (Z) 1st. Edition September 2000

Application

High speed and high voltage switching

Outline



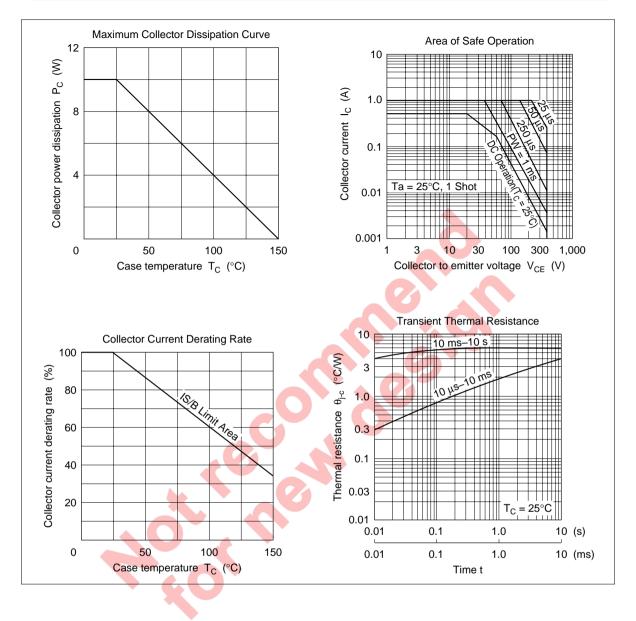
Absolute Maximum Ratings (Ta = 25°C)

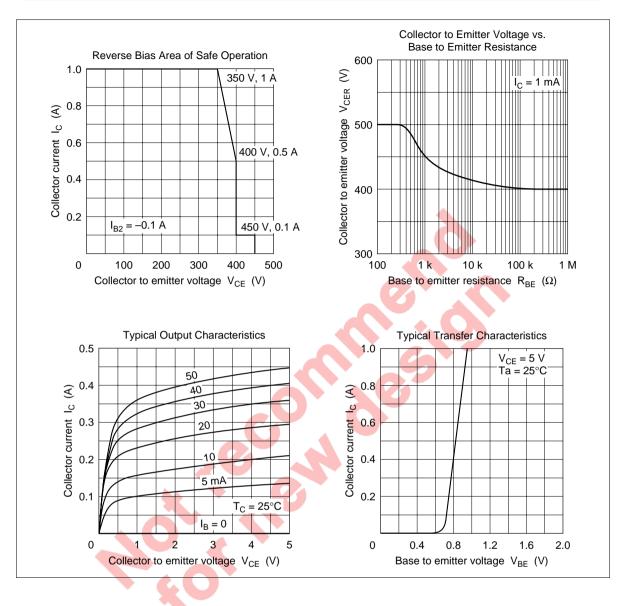
Item	Symbol	Ratings	Unit			
Collector to base voltage	V _{CBO}	500	V			
Collector to emitter voltage	V _{CEO}	400	V			
Emitter to base voltage	V _{EBO}	10	V			
Collector current	I _c	0.5	А			
Collector peak current	I _{C(peak)}	1.0	A			
Collector power dissipation	P _c	0.75	W			
	Pc*1	10				
Junction temperature	Тј	150	°C			
Storage temperature	Tstg	-55 to +150	°C			
Note: 1. Value at $T_c = 25^{\circ}C$. Electrical Characteristics (Ta = 25°C)						

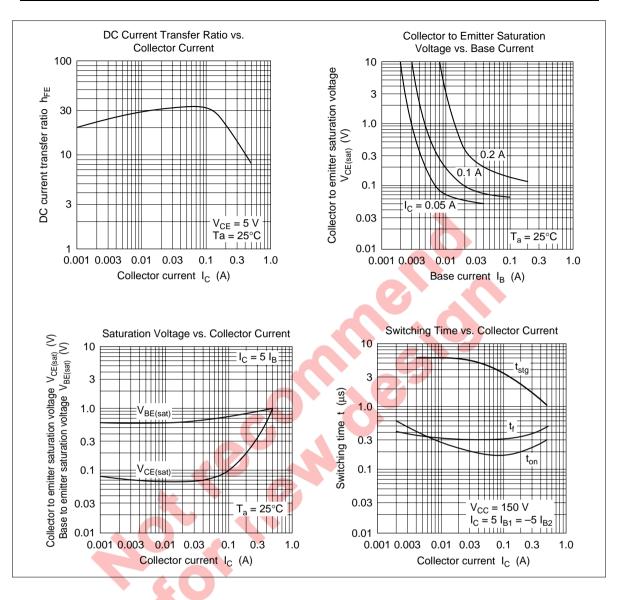
Electrical Characteristics (Ta = 25° C)

ltem	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter sustain voltage	$V_{\text{CEO}(\text{sus})}$	400		-	V	$I_{c} = 0.1 \text{ A}, R_{BE} = \infty$ L = 100 mH
Emitter to base breakdown voltage	V _{(BR)EBO}	10	_	0	V	$I_{\rm E} = 10$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	—		20	μA	$V_{CB} = 400 \text{ V}, I_{E} = 0$
	I _{CEO}	—	_	50		V_{ce} = 350 V, R_{be} = ∞
DC current transfer ratio	h _{FE1}	12		_		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 0.25 \text{ A}^{*1}$
	h _{FE2}	5	—	_		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 0.5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)}$		—	1.0	V	$I_{c} = 0.25 \text{ A}, I_{B} = 0.05 \text{ A}^{*1}$
Base to emitter saturation voltage	V _{BE(sat)}	_	_	1.5	V	$I_{c} = 0.25 \text{ A}, I_{B} = 0.05 \text{ A}^{*1}$
Turn on time	t _{on}	_	_	1.0	μs	$I_{\rm C} = 0.5 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 0.1 \text{ A},$
Storage time	t _{stg}	_	_	2.0	μs	$V_{cc} \cong 150 \text{ V}$
Fall time	t _f	—	_	1.0	μs	_

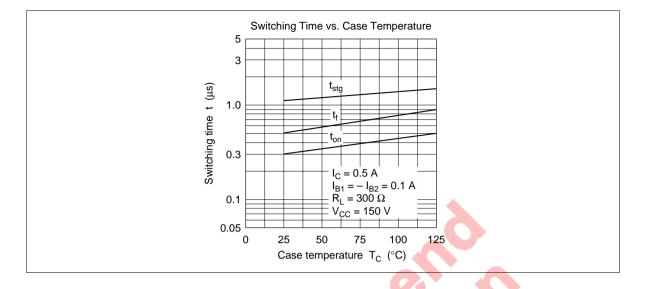
Note: 1. Pulse test.







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